

1H18 Results Presentation 29 January 2018

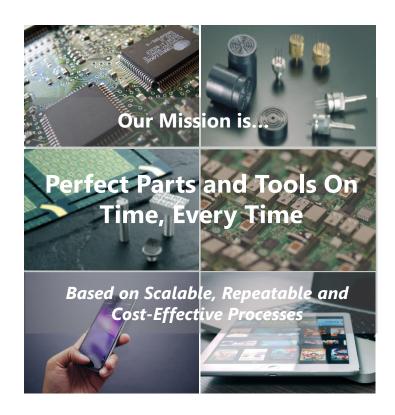


Business & Industry

Chris Borch, CEO Low Ming Wah, COO

Corporate Overview

- Founded in 1983 in Singapore
- Design and manufacture high precision tools and parts used in process-critical applications for the waferfabrication and assembly processes of the semiconductor industry
- Serve a worldwide base of customers from five facilities in Asia (Singapore, Malaysia, China, Philippines) and the USA
- More than 600 active customers
- Listed on the Singapore Exchange (Main Board) since 2003
- Committed to generating shareholder returns



Business Model

HIGH PRECISION, PROCESS-CRITICAL

Parts and Tools for Semiconductor Industry



Proprietary consumable tools used in the **assembly and testing of semiconductors**, such as die-attach and wirebonding tools

Contract manufacturing of precision parts used in process-critical applications for the wafer fabrication industry



IDMs, Semiconductor assembly and test service providers

Leading wafer fabrication equipment manufacturers



HIGH PRECISION AND QUALITY | SHORT CYCLE TIME | WORLDWIDE SUPPORT | VALUE > COST

Strategy - Focus on Key Customer Outcomes

End-user market demands flow through our Semiconductor Customers to Us

MARKET





Mobility + Performance "On-demand! Low Cost!"



SEMICONDUCTOR CUSTOMERS











KEY CUSTOMER OUTCOMES



DELIVERY On time, Every time in Less time

PRECISION Finer features, smaller tolerances

RELIABILITY Flawless Quality, 0 PPM

> COST Globally Competitive; Price < Value



Miniaturization + Reliability + Precision + Flawless Quality + Scalability



Strategy - Focus on Key Customer Outcomes

NANO PRECISION - the "Nano" world of semiconductor manufacturing

The "NANO" world of semiconductor manufacturing 32 22 14 10 7 2009 2011 2013 2015 2017 2019 Trend: Devices < 10 nanometers

Human hair = 100,000 nanometers

CUSTOMERS'

Requirements for Tools & Parts

Smaller features with tighter tolerances

Greater precision (Higher repeatability)

Towards zero defect

Micro-cleanliness

MICRO-MECHANICS:

Prepared for "Nano" world with **Capital** and **Engineering Resources**

MORE COMPLEX design and manufacturing

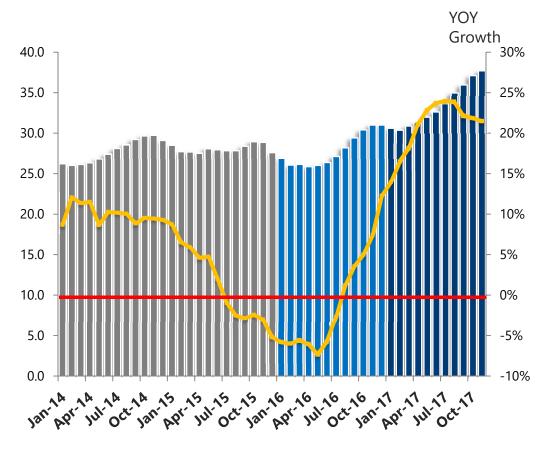
continuously develop advanced machining processes

SUPPORTING PROCESSES

– new materials, testing, cleaning & packaging

Industry Review

Global Monthly Chip Sales (US\$ B)

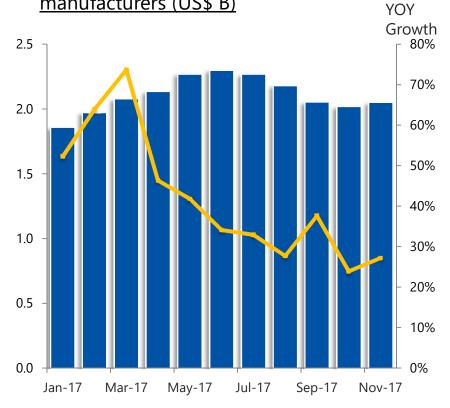


Source: Semiconductor Industry Association

- Worldwide chip sales in November 2017 reached the highest-ever monthly sales of US\$37.7 billion
- Global semiconductor sales for the five-month period from July to November 2017 increased
 22.6%, compared to the same period in 2016
- World Semiconductor Trade Statistics (WSTS)
 expects worldwide chip sales to reach a record
 US\$408.7 billion in 2017, up 20.6% from 2016
- WSTS projects semiconductor sales to increase another 7% in 2018

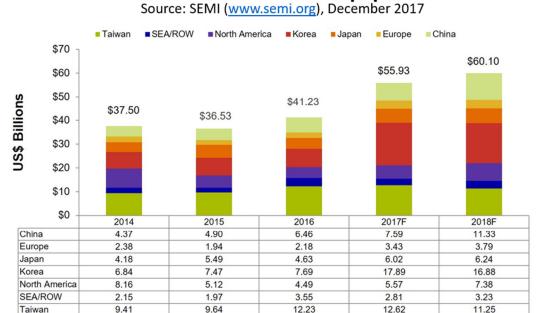
Industry Review

<u>Three-month average of worldwide</u> <u>billings of North American equipment</u> manufacturers (US\$ B)



Source: SEMI

SEMI Year-End Semiconductor Equipment Forecast



New equipment. Totals may not add due to rounding

SEMI projects 35.6% increase in worldwide sales of new semiconductor manufacturing equipment

- Sales to reach US\$55.9B in 2017, exceeding previous market high of US\$47.7B in 2000
- Expects 7.5% sales growth in 2018

1H18 Results Snapshot

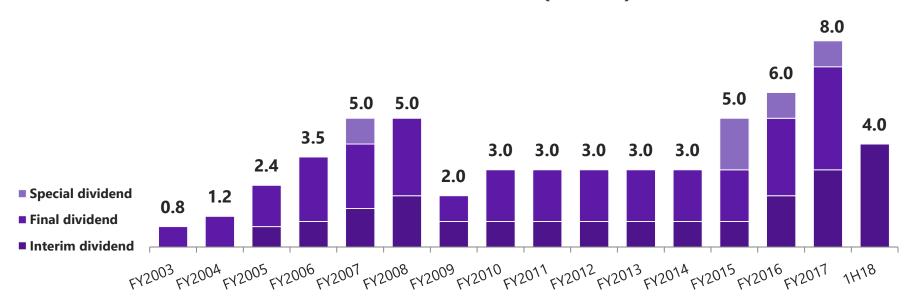
RECORD FIRST-HALF NET RECORD FIRST-HALF HIGHER GROSS PROFIT **PROFIT REVENUE MARGIN S\$9.1M S\$33.3M** 58.7% **34.6% 21.1%** ▲ 2.3ppt MARKET CAPITALISATION **ZERO BORROWINGS** INTERIM DIVIDEND **S\$333.7M S\$22.4M** 4.0 cents 22 JAN 2018 **IN CASH** PER SHARE

Dividend Performance

HIGHER INTERIM DIVIDEND OF 4 CENTS PER SHARE FOR 1H18

Total dividend payout since listing - **57.9 CENTS** per share

DIVIDEND PER SHARE (CENTS)



DIVIDEND PAYOUT RATIO

FY2003	FY2004	FY2005	FY2006	FY2007	FY2008	FY2009	FY2010	FY2011	FY2012	FY2013	FY2014	FY2015	FY2016	FY2017
29%	35%	61%	63%	83%	78%	513%	87%	61%	99%	81%	54%	58%	70%	75%

Dividend Policy of Not Less Than 40% of Earnings*

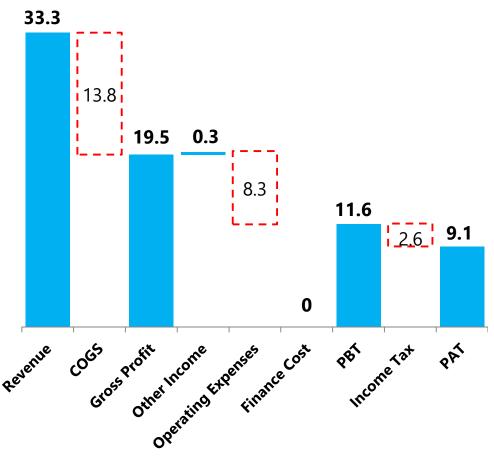


Financial Review

Chow Kam Wing, CFO

1H18 in Review

1H18 P&L Overview (S\$ million)



N.B. Due to rounding, some totals may not correspond with the sum/subtraction of separate figures.

KEY RATIOS & STATISTICS

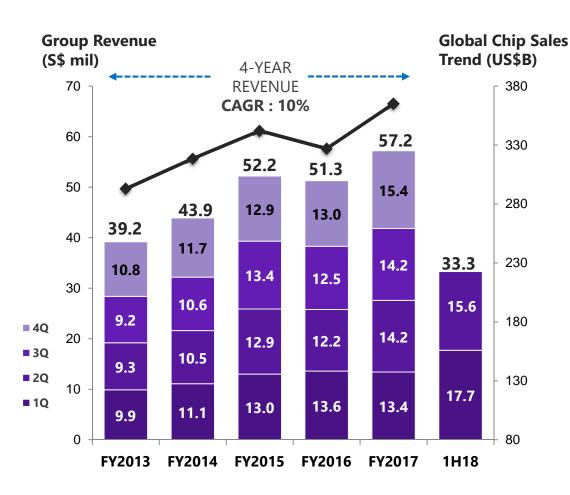
REVENUE GROWTH	21.1%
GROSS PROFIT GROV	VTH 26.0%
PBT GROWTH	32.7%
NET PROFIT GROWTI	H 34.6%
GROSS PROFIT MARC	GIN 58.7%
NET PROFIT MARGIN	27.2%
EARNINGS PER SHAF	RE 6.53 cents
RETURN ON EQUITY	31.7% (annualised)
CASH	S\$22.4M
DEBT	Zero

FY: Financial year ending 30 June



Group Revenue

RECORD FIRST-HALF REVENUE IN 1H18



Global Chip Sales Trend according to FY. Data from Semiconductor Industry Association (SIA)

N.B. Due to rounding, some totals may not correspond with the sum of separate figures.

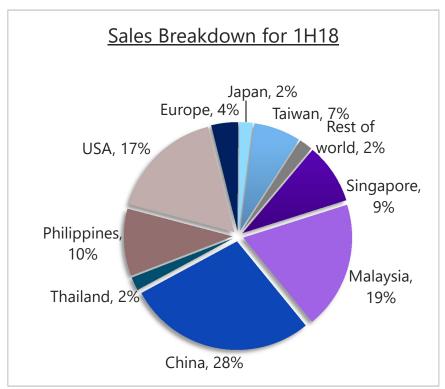
1H18 REVENUE **21.1%**

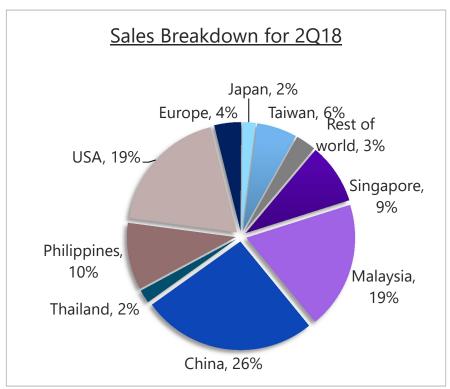
2Q18 REVENUE **10.3%**

- Higher sales in Singapore, the Philippines,
 China and the USA in 2Q18 vs 2Q17
- 2Q18 revenue would have been higher if not for the translational impact of the depreciation of the US dollar and the Philippine Peso by 2.6% and 7.1% respectively against the SGD

Group Revenue

DIVERSIFIED REVENUE STREAMS





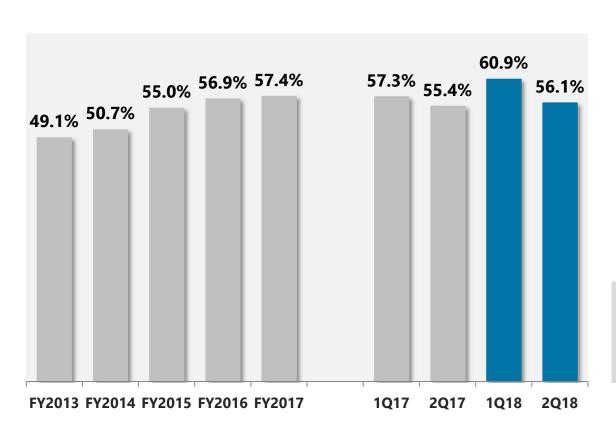
TOP 3 MARKETS

Country	1H18 S\$ mil	1H17 S\$ mil	% change
China	9.3	7.1	31%
Malaysia	6.4	6.1	5%
USA	5.7	3.9	45%

Country	2Q18 S\$ mil	2Q17 S\$ mil	% change
China	4.1	3.6	14%
Malaysia	2.9	3.1	(4%)
USA	3.0	2.2	34%

Gross Profit Margin

STEADY GROSS PROFIT MARGIN

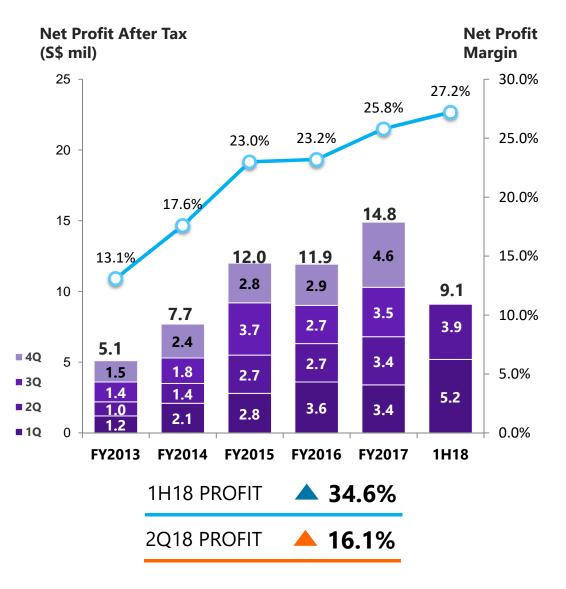


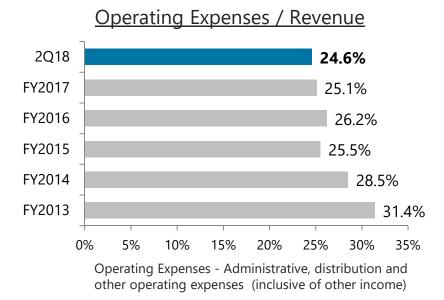
 Higher GP margin y-o-y attributed to higher capacity utilisation, as well as cost, productivity and cycle time improvements

Gross profit margin is one of the results that matters most – It reflects the **value we help to create for our customers**, and our ability to develop and deliver a **cost-effective outcome**

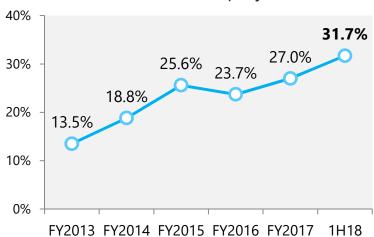
Profitability

RECORD FIRST-HALF NET PROFIT IN 1H18







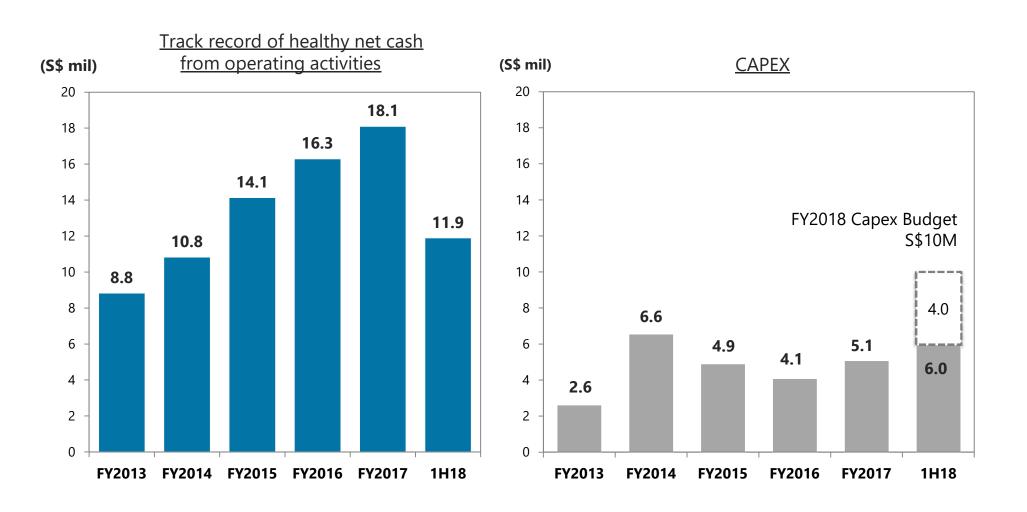


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Cash Flow

CASH-FLOW GENERATIVE OPERATIONS



Balance Sheet

		31 Dec 2017	30 June 2017
<u>Cash</u>	Cash and cash equivalents#	S\$22.4M	S\$23.4M
Gearing	Total borrowings	Nil	Nil
<u>Trade Receivables</u>	Trade Receivables (Outstanding > 90days) / (Total trade receivables) Bad debt expense	S\$11.0M Nil Nil (1H18)	S\$11.0M 0.1% Nil (FY17)
<u>Inventory</u>	Inventory Inventory / Sales Inventory write-off	S\$4.3M 6.4% S\$60k (1H18)	S\$3.7M 6.4% S\$102k (FY17)
<u>Equity</u>	Shareholders' equity# NAV per share	S\$57.2M 41.12 cents	S\$54.8M 39.39 cents

^{*} Paid final and special dividends totalling S\$7.0M for FY2017

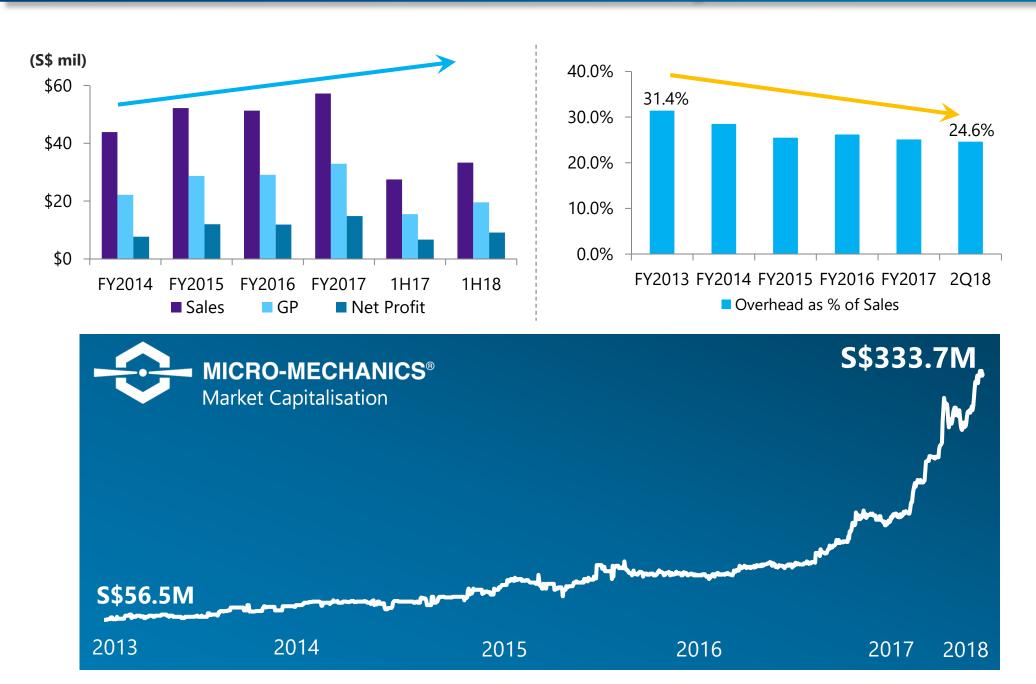




Key Takeaway

Chris Borch, CEO

Just One Takeaway ...





Safe Harbour for Forward-Looking Statements

This presentation contains certain statements that are not statements of historical fact, i.e. forward-looking statements. Investors can identify some of these statements by forward-looking items such as 'expect', 'believe', 'plan', 'intend', 'estimate', 'anticipate', 'may', 'will', 'would', and 'could' or similar words. However, you should note that these words are not the exclusive means of identifying forward-looking statements. These forward-looking statements are based on current expectations, projections and assumptions about future events. Although Micro-Mechanics (Holdings) Ltd. believes that these expectations, projections, and assumptions are reasonable, these forward-looking statements are subject to the risks (whether known or unknown), uncertainties and assumptions about Micro-Mechanics (Holdings) Ltd. and its business operations.

Some of the key factors that could cause such differences are, among others, the following:

- changes in the political, social and economic conditions and regulatory environment in the jurisdictions where we conduct business or expect to conduct business;
- the risk that we may be unable to realise our anticipated growth strategies and expected internal growth;
- changes in and new developments in technologies and trends;
- changes in currency exchange rates;
- changes in customer preferences and needs;
- changes in competitive conditions in the semiconductor industry and our ability to compete under these conditions;
- changes in pricing for our products; and
- changes in our future capital needs and the availability of financing and capital to fund these needs.

Given these risks, uncertainties and assumptions, the forward-looking events referred to in this presentation may not occur and actual results may differ materially from those expressly or impliedly anticipated in these forward-looking statements. Investors are advised not to place undue reliance on these forward-looking statements.

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